19-5199; Rev 0; 9/10

EVALUATION KIT AVAILABLE

Dual 36V Op Amp for 18-Bit SAR ADC Front-End

MAX9633

General Description

The MAX9633 is a low-noise, low-distortion operational amplifier that is optimized to drive ADCs for use in applications from DC to a few MHz. The MAX9633 features low noise (3nV/√Hz at 1kHz and 3.5nV/√Hz at 100Hz) and low distortion (130dB at 10kHz), making it suitable for industrial, medical, and test applications.

The exceptionally fast settling-time and low input offset voltage makes the IC an excellent solution to drive high-resolution 12-bit to 18-bit SAR ADCs.

The IC operates from a wide supply voltage range up to 36V with only 3.5mA of quiescent current per amplifier.

The IC is offered in an 8-pin, 3mm x 3mm TDFN package for operation over the -40°C to +125°C temperature range.

Features

- **Low-Noise (3nV/√Hz at 1kHz) and Low-Distortion (130dB at 10kHz) ADC Driver**
- **Very Fast 750ns Settling Time to 16-Bit Accuracy**
- **Low Input Voltage Offset 200µV (max)**
- **Low 0.9µV/°C Input Offset Temperature Coefficient**
- **Gain-Bandwidth Product 27MHz**
- **4.5V to 36V Wide Supply Range**
- **Unity Gain Stable**
- **±6kV ESD Protection HBM**
- **8-Pin, 3mm x 3mm TDFN Package**

Applications

ADC Drivers

Data Acquisition and Instrumentation

Power Grid Systems

Motor Control

Test and Measurement Equipments

Imaging Systems

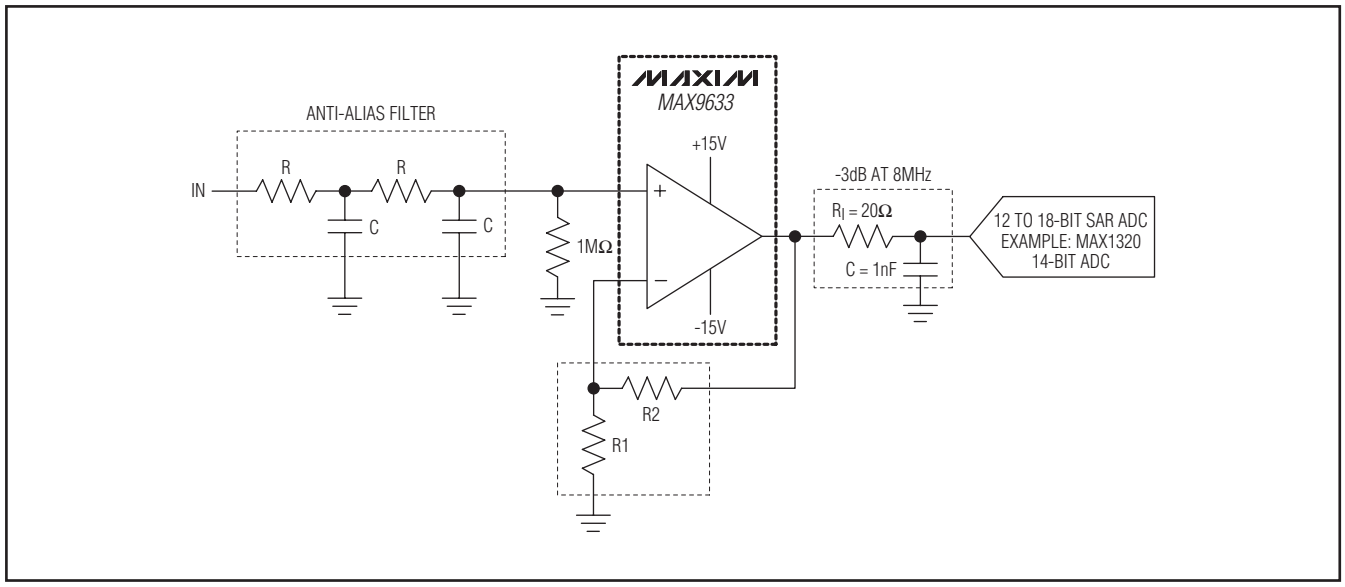
High-Performance Audio Circuitry

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX9633ATA+	-40°C to +125°C	8 TDFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.
**EP = Exposed pad.*

Typical Application Circuit



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Dual 36V Op Amp for 18-Bit SAR ADC Front-End

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC} to V_{EE}) ..... -0.3V to +40V
All Other Pins ..... (V_{EE} - 0.3V) to (V_{CC} + 0.3V)
Short-Circuit Duration of OUTA, OUTB 10s
Continuous Input Current (any pins) ..... ±20mA
Continuous Power Dissipation (T_A = +70°C)
TDFN (derate 24.4mW/°C above +70°C)
Multilayer Board 1904.8mW

Package Thermal Resistance (Note 1)
θ_{JA} ..... 42°C/W
θ_{JC} ..... 8°C/W
Operating Temperature Range ..... -40°C to +125°C
Junction Temperature ..... +150°C
Storage Temperature Range ..... -65°C to +150°C
Soldering Temperature (reflow) ..... +260°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maxim-ic.com/thermal-tutorial**.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +15V, V_{EE} = -15V, V_{CM} = 0V, R_L = 10kΩ to V_{GND} = 0V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
POWER SUPPLY							
Supply Voltage Range	V_{CC} - V_{EE}	Guaranteed by PSRR		4.5		36	V
Supply Current	I_{CC}	Per amplifier	T_A = +25°C		3.5	5	mA
			-40°C ≤ T_A ≤ +85°C			6	
			-40°C ≤ T_A ≤ +125°C			6.5	
Power-Supply Rejection Ratio	PSRR	+4.5V ≤ (V_{CC} - V_{EE}) ≤ +36V	T_A = +25°C	112	135		dB
			-40°C ≤ T_A ≤ +125°C	110			
DC SPECIFICATIONS							
Input Offset Voltage	V_{OS}	T_A = +25°C			±70	±200	µV
		-40°C ≤ T_A ≤ +125°C				±290	
Input Offset Voltage Drift (Note 3)	ΔV_{OS}	-40°C ≤ T_A ≤ +125°C			0.2	0.9	µV/°C
Input Bias Current	I_B	(V_{EE} + 0.45V) ≤ V_{CM} ≤ (V_{CC} - 1.8V)			±42	±400	nA
		V_{EE} ≤ V_{CM} ≤ (V_{CC} - 1.8V)			4.5	22	µA
Input Offset Current	I_{OS}	(V_{EE} + 0.45V) ≤ V_{CM} ≤ (V_{CC} - 1.8V)			±30	±300	nA
		V_{EE} ≤ V_{CM} ≤ (V_{CC} - 1.8V)			±200	±2000	
Input Voltage Range	V_{IN+}, V_{IN-}	Guaranteed by CMRR	T_A = +25°C	V_{EE}		V_{CC} - 1.7	V
			-40°C ≤ T_A ≤ +125°C	V_{EE}		V_{CC} - 1.8	
Common-Mode Rejection Ratio	CMRR	V_{EE} ≤ V_{CM} ≤ (V_{CC} - 1.7V), T_A = +25°C		106	130		dB
		V_{EE} ≤ V_{CM} ≤ (V_{CC} - 1.8V), -40°C ≤ T_A ≤ +125°C		105	130		
Open-Loop Gain	A_{VOL}	(V_{EE} + 0.3V) ≤ V_{OUT} ≤ (V_{CC} - 2V), R_L = 10kΩ		118	140		dB
		(V_{EE} + 0.45V) ≤ V_{OUT} ≤ (V_{CC} - 2.1V), R_L = 1kΩ		115	138		

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +15V, V_{EE} = -15V, V_{CM} = 0V, R_L = 10kΩ to V_{GND} = 0V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Output Voltage Swing	V_{OH}	V_{CC} - V_{OUT}	R_L = 10kΩ		1.6	1.9	V
			R_L = 1kΩ		1.7	2.0	
	V_{OL}	V_{OUT} - V_{EE}	R_L = 10kΩ		70	150	mV
			R_L = 1kΩ		170	300	
			R_L = 10kΩ to V_{EE}		20	100	
			R_L = 1kΩ to V_{EE}		20	100	
Short-Circuit Current	I_{SC}	T_A = +25°C			50		mA
AC SPECIFICATIONS							
Gain Bandwidth	GBWP				27		MHz
Slew Rate	SR	5V step, R_S = 20Ω, C_L = 1nF, A_V = 1V/V			18		V/µs
Output Transient Recovery Time	t_{TR}	To 0.001%, ΔV_{OUT} = 200mV, R_S = 20Ω, C_L = 1nF, AV = +1V/V			500		ns
Settling Time	t_S	To 0.001%, 5V step, AV = -1V/V	R_S = 100Ω, C_L = 30pF		750		ns
			R_S = 20Ω, C_L = 1nF		750		
Total Harmonic Distortion	THD	V_{OUT} = 10V_{P-P}, R_S = 20Ω, C_L = 1nF, A_V = +1V/V	f = 1kHz		145		dB
			f = 10kHz		130		
			f = 100kHz		-100		
Crosstalk		V_{OUT} = 10V_{P-P}, R_S = 20Ω, C_L = 1nF	f = 1kHz		-100		dB
			f = 10kHz		-90		
Input Voltage Noise Density	e_n	f = 100Hz			3.5		nV/√Hz
		f = 1kHz			3		
Input Voltage Noise		0.1Hz ≤ f ≤ 10Hz			250		nV_{P-P}
Input Current Noise Density	i_n	f = 100Hz			12		pA/√Hz
		f = 1kHz			10		
Capacitive Loading	C_L	No sustained oscillation, A_V = +1V/V			50		pF

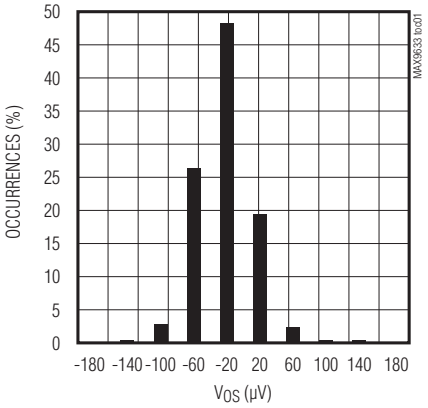
Note 2: All devices are 100% production tested at T_A = +25°C. Temperature limits are guaranteed by design.
Note 3: Guaranteed by design.

Dual 36V Op Amp for 18-Bit SAR ADC Front-End

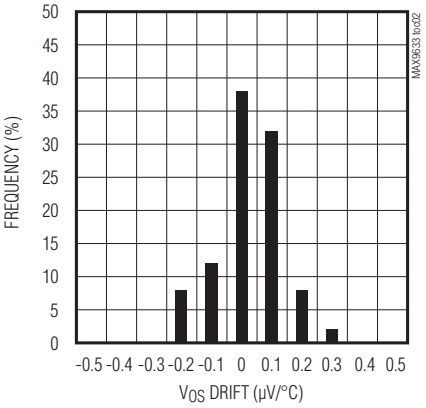
Typical Operating Characteristics

(V_{CC} = +15V, V_{EE} = -15V, V_{CM} = 0V, outputs have R_L = 10kΩ connected to GND = 0V. Typical values are at T_A = +25°C, unless otherwise noted.)

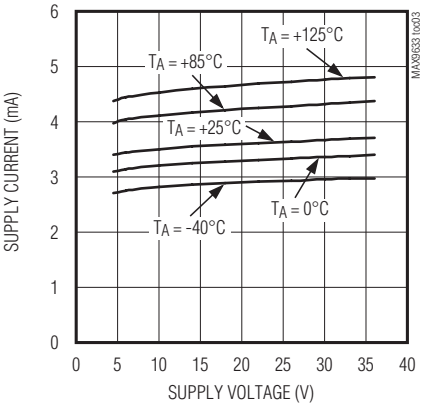
V_{OS} HISTOGRAM



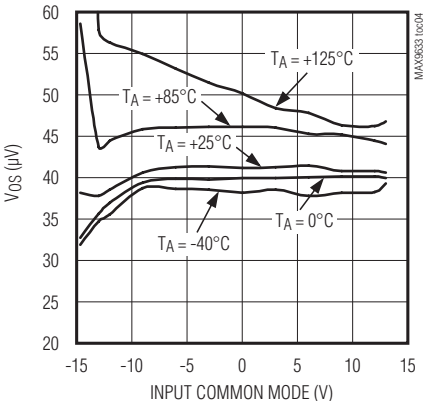
V_{OS} DRIFT HISTOGRAM



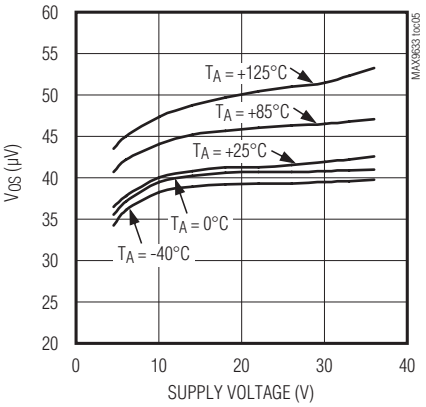
SUPPLY CURRENT vs. SUPPLY VOLTAGE



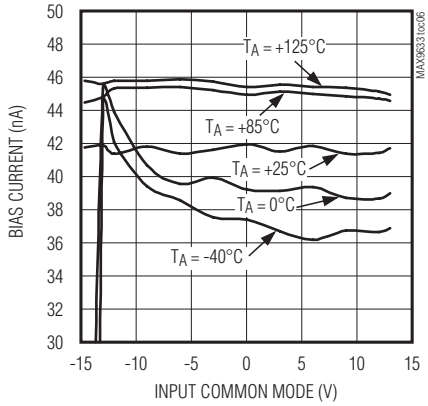
INPUT OFFSET VOLTAGE vs. INPUT COMMON MODE



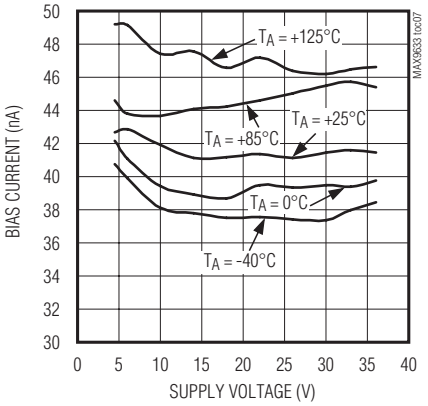
INPUT OFFSET VOLTAGE vs. SUPPLY VOLTAGE



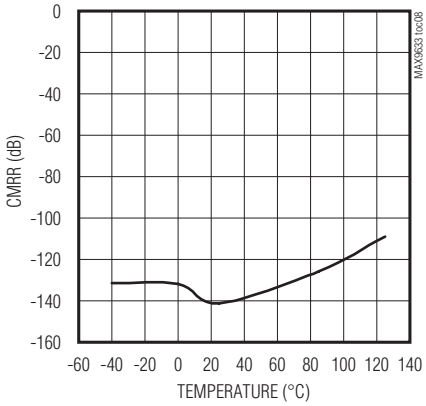
BIAS CURRENT vs. INPUT COMMON MODE



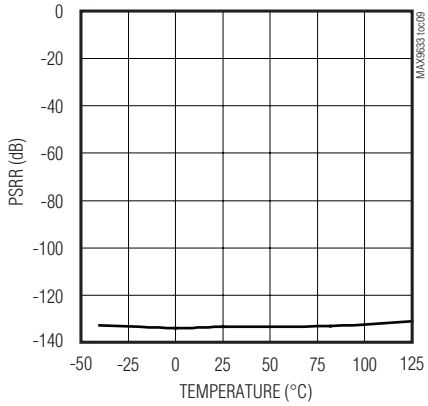
BIAS CURRENT vs. SUPPLY VOLTAGE



DC COMMON-MODE REJECTION RATIO vs. TEMPERATURE



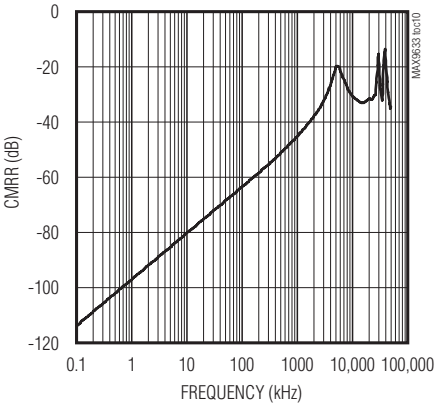
DC PSRR vs. TEMPERTURE



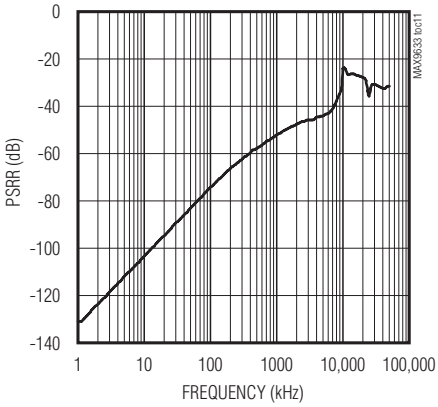
Typical Operating Characteristics (continued)

(V_{CC} = +15V, V_{EE} = -15V, V_{CM} = 0V, outputs have R_L = 10kΩ connected to GND = 0V. Typical values are at T_A = +25°C, unless otherwise noted.)

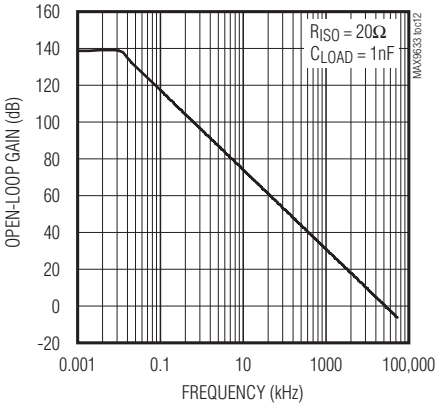
COMMON-MODE REJECTION RATIO vs. FREQUENCY



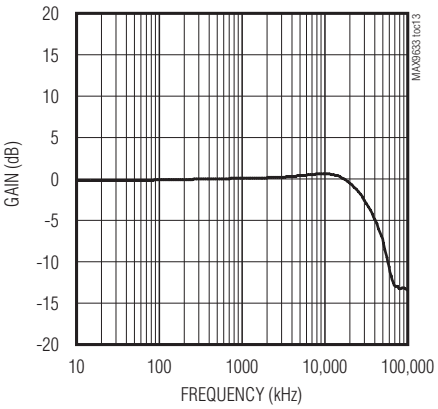
POWER-SUPPLY REJECTION RATIO vs. FREQUENCY



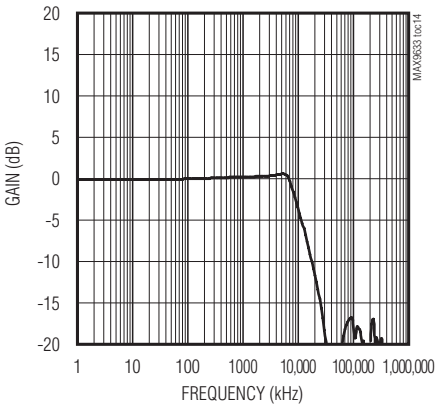
OPEN-LOOP GAIN vs. FREQUENCY



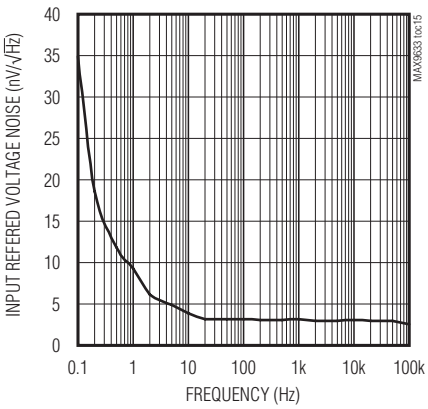
SMALL-SIGNAL UNITY GAIN vs. FREQUENCY



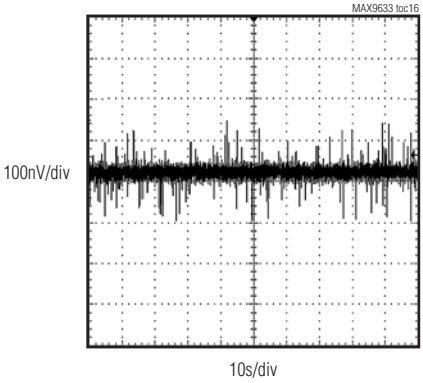
LARGE-SIGNAL UNITY GAIN vs. FREQUENCY



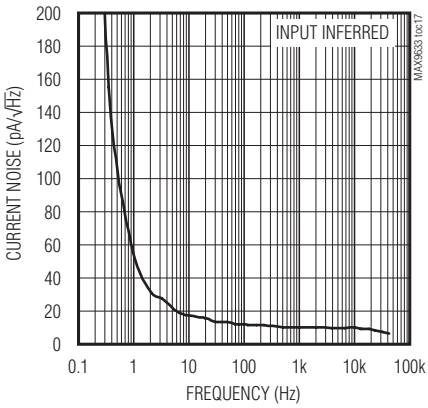
INPUT REFERED VOLTAGE NOISE vs. FREQUENCY



0.1Hz TO 10Hz NOISE vs. TIME



CURRENT NOISE vs. FREQUENCY

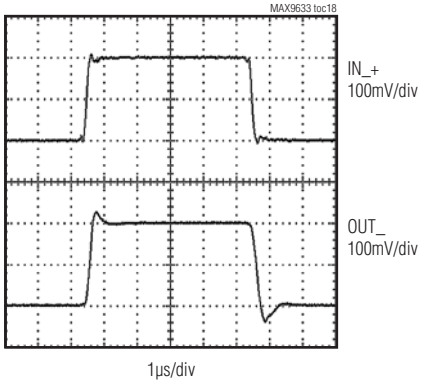


Dual 36V Op Amp for 18-Bit SAR ADC Front-End

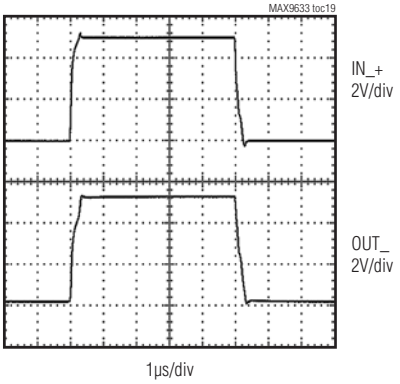
Typical Operating Characteristics (continued)

(V_{CC} = +15V, V_{EE} = -15V, V_{CM} = 0V, outputs have R_L = 10kΩ connected to GND = 0V. Typical values are at T_A = +25°C, unless otherwise noted.)

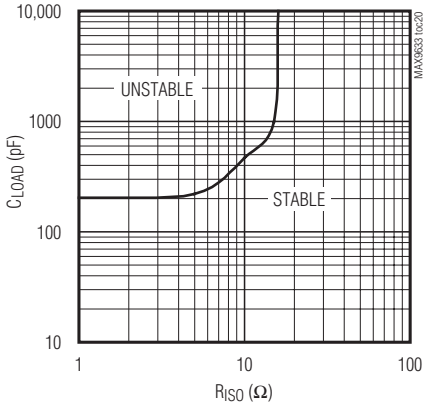
SMALL-SIGNAL STEP RESPONSE vs. TIME



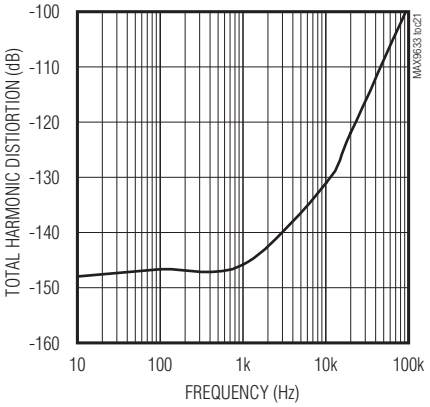
LARGE-SIGNAL STEP RESPONSE vs. TIME



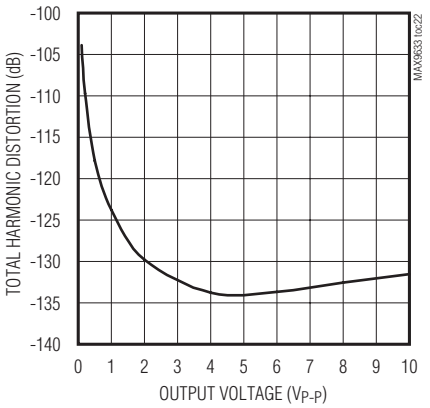
CAPACITIVE LOAD vs. ISOLATION RESISTOR



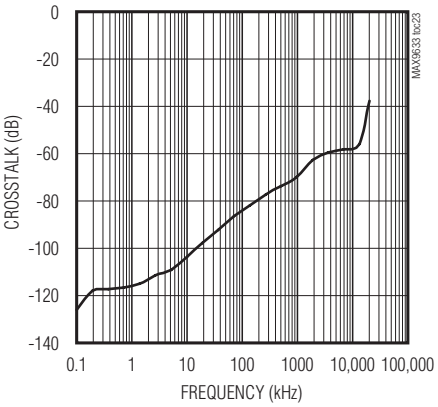
TOTAL HARMONIC DISTORTION vs. FREQUENCY V_{OUT} = 10V_{P-P}



THD vs. OUTPUT VOLTAGE FREQUENCY = 10kHz



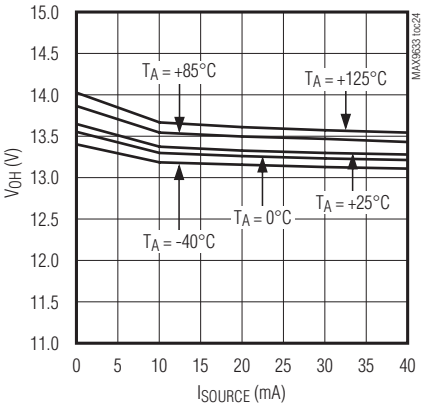
CROSSTALK vs. FREQUENCY



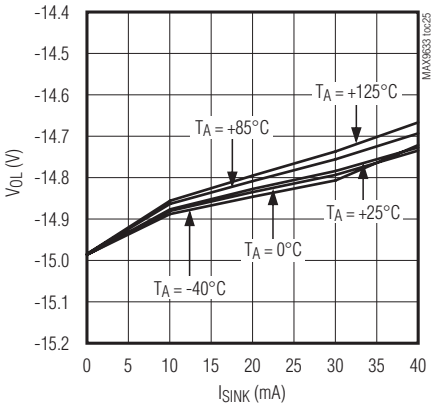
Typical Operating Characteristics (continued)

(V_{CC} = +15V, V_{EE} = -15V, V_{CM} = 0V, outputs have R_L = 10kΩ connected to GND = 0V. Typical values are at T_A = +25°C, unless otherwise noted.)

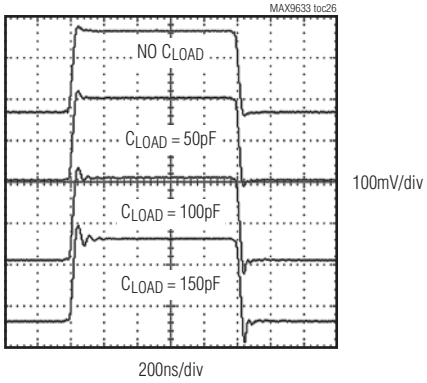
OUTPUT VOLTAGE HIGH vs. SOURCE CURRENT



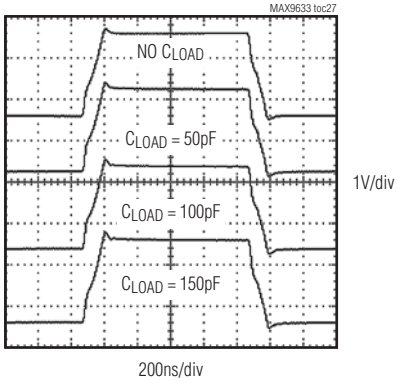
OUTPUT VOLTAGE LOW vs. SINK CURRENT



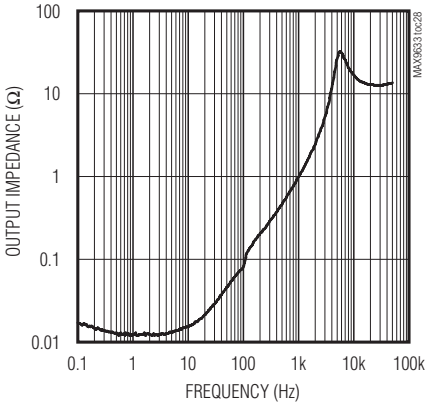
100mV STEP RESPONSE WITH C_{LOAD}



2V STEP RESPONSE WITH C_{LOAD}

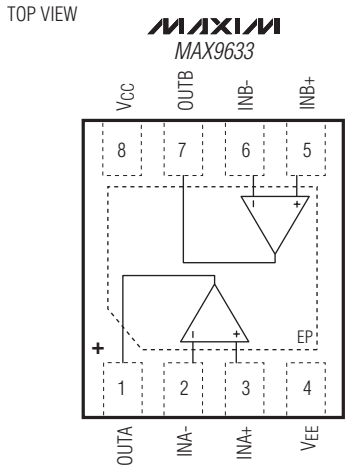


OUTPUT IMPEDANCE vs. FREQUENCY



Dual 36V Op Amp for 18-Bit SAR ADC Front-End

Pin Configuration



TQFN-EP

EP = EXPOSED PAD. CONNECT TO V_{EE} EXTERNALLY OR LEAVE UNCONNECTED.

Pin Description

PIN	NAME	FUNCTION
1	OUTA	Output A
2	INA-	Negative Input A
3	INA+	Positive Input A
4	V_{EE}	Negative Supply Voltage. Bypass with a 0.1µF capacitor to ground.
5	INB+	Positive Input B
6	INB-	Negative Input B
7	OUTB	Output B
8	V_{CC}	Positive Supply Voltage. Bypass with a 0.1µF capacitor to ground.
—	EP	Exposed Pad. Connect to V_{EE} externally or leave unconnected.

Detailed Description

The MAX9633 is designed in a new 36V, high-speed complementary BiCMOS process that is optimized for excellent AC dynamic performance combined with high-voltage operation.

The exceptionally fast settling time, low noise, low distortion, high bandwidth, and low input offset voltage make the IC an excellent solution to drive (up to 18-bit)high-resolution and fast SAR ADCs.

The MAX9633 is unity gain stable and operates either with a single supply voltage up to 36V or with dual supplies up to ±18V.

Applications Information

Driving High-Resolution SAR ADCs

High-resolution SAR ADCs typically switch an input capacitor in the order of tens of pF during the track and hold phases. Such capacitor switching can cause a voltage glitch at the input of the ADC that behaves as a load-transient condition for the driving amplifier. In many applications, this glitch is avoided by placing an external capacitor at the ADC input that is in the order of 20 to 50 times the ADC input capacitor. If the ADC input capacitor ranges from 15pF to 30pF, then the external capacitor is anything between 300pF to 1.5nF, depending on the application. An isolation resistor can be placed in series between the amplifier's output and the external capacitor, as shown in the *Typical Application Circuit*.

During the load-transient condition described, the driving amplifier must be able to settle to 0.5 x LSB within the ADC acquisition time (t_{ACQ}). Assuming a first order approximation, the number of time constants required to settle to 0.5 x LSB is a logarithm function of the number N of bits:

1) $$k = \ln\left(2^{N+1}\right)$$

The external RC time constant must be such that:

2) $$k \times R_L \times C < t_{ACQ}$$

As an example, consider a 16-bit SAR ADC with 500ns acquisition time and 20pF input capacitor.

From 1): $k = 12$

Assuming a factor of 50 for the external capacitor:

$$C = 1nF$$

Finally, formula 2) gives: $R_L \leq 40\Omega$

The IC is optimized for very fast load-transient recovery with big capacitive loads and small isolation resistors. This makes it ideal to drive high-resolution and fast SAR ADCs.

Recommended SAR ADCs

The MAX9633's wide supply range and fast settling make it ideal for driving high-resolution SAR ADCs, such as the MAX1320. The MAX1320 is a 14-bit, 8-channel, simultaneous-sampling ADC that measures analog inputs up to ±5V. Sampling up to 250ksps per channel for eight channels, the MAX1320 achieves 77dB SNR, 90dBc SFDR, and -86dB THD. The MAX1320's fast sample rate and typical input resistance of 8.6kΩ often make it necessary to have a low-noise op amp, such as the MAX9633, driving its inputs. The MAX9633 is also a good fit for an anti-aliasing active filter prior to the MAX1320 as shown in the *Typical Application Circuit*.

The MAX1320 is part of a family of simultaneous sampling ADCs (MAX1316–MAX1326). Other options include ADCs that measure 0V to 5V inputs, or ±10V inputs, and two 4 or 8 simultaneous input channels. The MAX1320's high speed and resolution make it a fit for multiphase motor control and power-grid monitoring.

The MAX9633 is also well-suited to drive the 16-bit MAX11046 8-channel, simultaneous-sampling, SAR ADC. The MAX11046 is rated for up to 250ksps. An input driver is typically not necessary at sampling rates below 100ksps. For applications that require > 100ksps sample rates, the MAX9633 offers small size, high bandwidth, and ultra-low -100dB THD at 100kHz.

Low Noise and Low Distortion

The MAX9633 is designed for applications that require very low voltage noise, making it ideal for low source impedance. When driving 16-bit SAR ADCs with a ±5V full-scale input, such as the MAX11046, the MAX9633 very low input voltage noise density specification guarantees 16-bit resolution up to 10MHz of signal bandwidth.

The MAX9633 is also designed for ultra-low distortion performance. THD specifications in the *Electrical Characteristics* and *Typical Operating Characteristics* is calculated up to the 5th harmonic. Even when driving high voltage swing up to $10V_{P-P}$, the MAX9633 maintains excellent low distortion operation up and beyond 100kHz of bandwidth.

Besides driving high-resolution and high-bandwidth SAR ADCs, applications that benefit for low-noise and low-distortion applications can be found in industrial power-grid and smart-grid, industrial motor-control, medical imaging, automated test equipment, instrumentation, and professional audio equipment.

Dual 36V Op Amp for 18-Bit SAR ADC Front-End

Input Common Mode and Output Swing

The IC's input common-mode range as well as the output range can swing to the negative rail V_{EE}. These two features are very important for applications where the MAX9633 is used with a single supply (V_{EE} connected to ground). In such a case, being able to swing the input common-mode to the negative rail offers ground-sensing capability.

Input Differential Voltage Protection

During normal op-amp operation, the inverting and non-inverting inputs of the IC are at essentially the same voltage. However, either due to fast input voltage transients or due to other fault conditions, these pins can be forced to be at two different voltages.

Internal back-to-back diodes protect the inputs from an excessive differential voltage (Figure 1). Therefore, IN+ and IN- can be any voltage within the range shown in the *Absolute Maximum Ratings*. Note the protection time is still dependent on the package thermal limits.

If the input signal is fast enough to create the internal diode's forward bias condition (0.7), the input signal current must be limited to 20mA or less. If the input signal current is not inherently limited, an external input series resistor can be used to limit the signal input current. Care should be taken in choosing the input series resistor value, since it degrades the low-noise performance of the device.

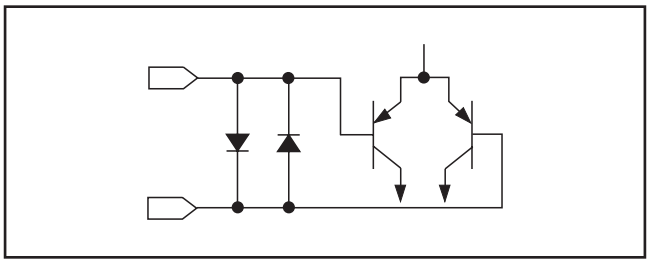


Figure 1. Input Protection Circuit

Electrostatic Discharge (ESD)

The IC has built-in circuits to protect from electrostatic discharge (ESD) events. An ESD event produces a short, high-voltage pulse that is transformed into a short current pulse once it discharges through the device. The built-in protection circuit provides a current path around the op amp that prevents it from being damaged. The energy absorbed by the protection circuit is dissipated as heat. ESD protection is guaranteed up to 6kV with the Human Body Model (HBM).

The Human Body Model simulates the ESD phenomenon wherein a charged body directly transfers its accumulated electrostatic charge to the ESD-sensitive device. A common example of this phenomenon is when a person accumulates static charge by walking across a carpet and then transfers all of the charge to an ESD-sensitive device by touching it.

Power Supplies and Layout

The IC can operate with dual supplies from ±2.25V to ±18V or with a single supply from +4.5V to +36V with respect to ground. When used with dual supplies, bypass both V_{CC} and V_{EE} with their own 0.1µF capacitor to ground. When used with a single supply, bypass V_{CC} with a 0.1µF capacitor to ground. Careful layout technique helps optimize performance by decreasing the amount of stray capacitance at the op amp's inputs and outputs. To decrease stray capacitance, minimize trace lengths by placing external components close to the op amp's pins.

For high-frequency designs, ground vias are critical to provide a ground return path for high-frequency signals and should be placed around the signal traces and near the decoupling capacitors. Signal routing should be short and direct to avoid parasitic effects. Avoid using right angle connectors since they may introduce a capacitive discontinuity and ultimately limit the frequency response.

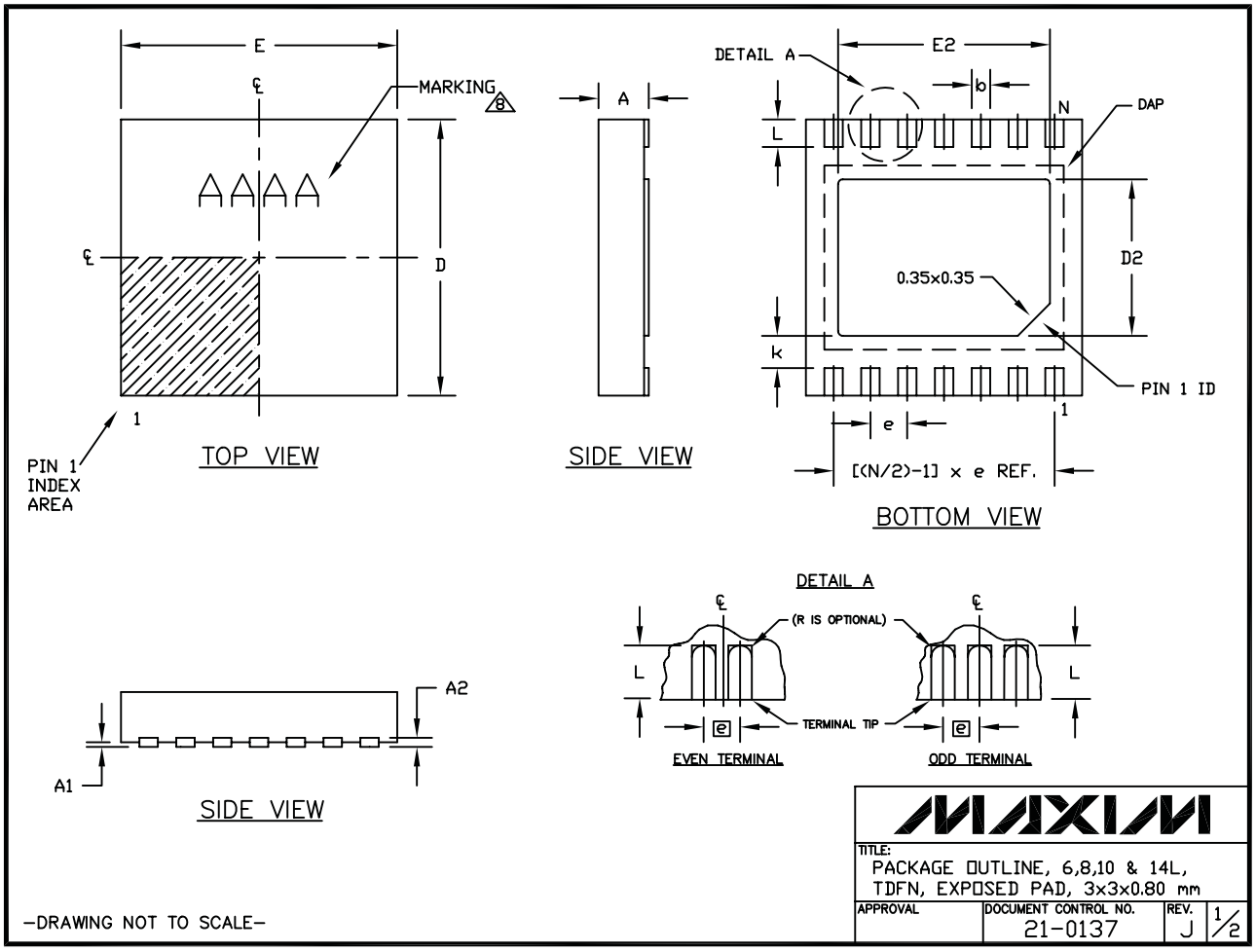
Chip Information

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
8 TDFN-EP	T833+3	21-0137	90-0058



Dual 36V Op Amp for 18-Bit SAR ADC Front-End

Package Information (continued)

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages.** Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033MK-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF
T1433-3F	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
9. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODES.

-DRAWING NOT TO SCALE-

MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	J	2/2

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	9/10	Initial release	—

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